IPC ASSOCIATION COLELECTRONICS IN	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					terials and	ials and Mfg Information			
upplier Ir	nformation	,							,						
Company name*				Company unique ID			Unique ID Authority				Respo	Response Date*			
nsemi											2024-0	2024-05-04			
Contact Name	e	Title - Contact			I	Phone - Contact*				Email	Email - Contact*				
Product-Env	-Stewards		Product Enviro Compliance]	NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized R	Representative*	Title - Representative			I	Phone - Representative*				Email	Email - Representative*				
roduct-Env	-Stewards		Product Enviro Compliance]	NA				Produ	Product-Env-Stewards@onsemi.com			
Re	equester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
		LC75805PES-3H LED AND LC		LED AND LCD DI	CD DISPLAY DRIVER		2024-05-04			1500.0		mg	Each		
	uring Process Informa		'arminal Paga	Alloy	STD-020 MSI	Dating	Paul Proge	on Pady T	amparatur	May Time at D	ook Tompo	roturo Num	ber of Reflow Cy	plag	
ě ,		Terminal Base Alloy J-ST CU Alloy 3		S I D-020 MSI	_ Kaung	260	ss Body Temperature Max Time at Peak C 30			seconds 3		cies			
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omments	N. MCI 2 Dated item	og Dolvo om J D	wy Dools (cft-	w algorithms to set											
	N: MSL 3 Rated item requir ormation regarding materia		•	,											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	9.52	mg	Supplier	Silicon (Si)	7440-21-3		9.4591	mg
			Supplier	Polyimide	Proprietary Data		0.0609	mg
Die Attach	0.93	mg	Supplier	Silver (Ag)	7440-22-4		0.7114	mg
			Supplier	Epoxy resins	129915-35-1		0.2185	mg
Lead Frame	350.5	mg	Supplier	Silver (Ag)	7440-22-4		0.5079	mg
			Supplier	Zinc (Zn)	7440-66-6		0.4374	mg
			Supplier	Iron (Fe)	7439-89-6		8.2248	mg
			Supplier	Copper (Cu)	7440-50-8		341.041	mg
			Supplier	Phosphorus (P)	7723-14-0		0.2888	mg
Mold Compound-Black	1126.51	mg		Phenolic Resin	proprietary data		56.3255	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		31.5423	mg
			Supplier	Carbon Black (C)	1333-86-4		11.2651	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		33.7953	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		901.208	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		90.1208	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		2.2529	mg
Plating	10.65	mg	В	Bismuth (Bi)	7440-69-9		0.0639	mg
			Supplier	Tin (Sn)	7440-31-5		10.5861	mg
Wire Bond	1.89		Supplier	Palladium (Pd)	7440-05-3		0.0189	mg
			Supplier	Gold (Au)	7440-57-5		1.8711	mg